

# Global Die Attach Carrier Substrate Supply, Demand and Key Producers, 2023-2029

<https://marketpublishers.com/r/G2A8810B7AC5EN.html>

Date: September 2023

Pages: 121

Price: US\$ 4,480.00 (Single User License)

ID: G2A8810B7AC5EN

## Abstracts

The global Die Attach Carrier Substrate market size is expected to reach \$ million by 2029, rising at a market growth of % CAGR during the forecast period (2023-2029).

Chip attach carrier substrate refers to the substrate used to attach chips (such as integrated circuit chips) to it. In the electronic manufacturing process, the die attach carrier substrate plays the role of fixing and supporting the chip. Die-attach carrier substrates are usually made of conductive materials such as metals or conductive polymers. It has good electrical and thermal conductivity, which can provide stable electrical connection and heat dissipation. During the die attach process, the die is precisely placed on the carrier substrate and fixed using an appropriate adhesive or soldering process. The carrier substrate may also contain circuit connectors, pins, or other electronic components for connection and integration with other components. The design and manufacture of die-attached carrier substrates need to consider factors such as chip size, pin layout, and heat dissipation requirements. It plays an important role in the manufacture of electronic devices, ensuring the stability, reliability and performance of chips.

This report studies the global Die Attach Carrier Substrate production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Die Attach Carrier Substrate, and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2022 as the base year. This report explores demand trends and competition, as well as details the characteristics of Die Attach Carrier Substrate that contribute to its increasing demand across many markets.

## Highlights and key features of the study

Global Die Attach Carrier Substrate total production and demand, 2018-2029, (K Units)

Global Die Attach Carrier Substrate total production value, 2018-2029, (USD Million)

Global Die Attach Carrier Substrate production by region & country, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Die Attach Carrier Substrate consumption by region & country, CAGR, 2018-2029 & (K Units)

U.S. VS China: Die Attach Carrier Substrate domestic production, consumption, key domestic manufacturers and share

Global Die Attach Carrier Substrate production by manufacturer, production, price, value and market share 2018-2023, (USD Million) & (K Units)

Global Die Attach Carrier Substrate production by Type, production, value, CAGR, 2018-2029, (USD Million) & (K Units)

Global Die Attach Carrier Substrate production by Application production, value, CAGR, 2018-2029, (USD Million) & (K Units).

This reports profiles key players in the global Die Attach Carrier Substrate market based on the following parameters – company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Kyocera, Shinko Electric Industries, Hitachi Chemical, Sumitomo Bakelite, Mitsui High-tec, Nippon Electric Glass, Toray Industries, Panasonic and LG Innotek, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Die Attach Carrier Substrate market.

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (K Units) and average price (US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2018-2029 by year with 2022 as the base year, 2023 as the estimate year, and 2024-2029 as the forecast year.

#### Global Die Attach Carrier Substrate Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

#### Global Die Attach Carrier Substrate Market, Segmentation by Type

PCB Substrate

Si Substrate

GaAs Substrate

SiC Substrate

#### Global Die Attach Carrier Substrate Market, Segmentation by Application

Automobile Industry

Medical Industry

Aerospace Industry

Others

Companies Profiled:

Kyocera

Shinko Electric Industries

Hitachi Chemical

Sumitomo Bakelite

Mitsui High-tec

Nippon Electric Glass

Toray Industries

Panasonic

LG Innotek

Samsung Electro-Mechanics

Murata Manufacturing

Taiyo Yuden

TDK Corporation

KEMET Corporation

Vishay Intertechnology

## Key Questions Answered

1. How big is the global Die Attach Carrier Substrate market?
2. What is the demand of the global Die Attach Carrier Substrate market?
3. What is the year over year growth of the global Die Attach Carrier Substrate market?
4. What is the production and production value of the global Die Attach Carrier Substrate market?
5. Who are the key producers in the global Die Attach Carrier Substrate market?

## Contents

### 1 SUPPLY SUMMARY

- 1.1 Die Attach Carrier Substrate Introduction
- 1.2 World Die Attach Carrier Substrate Supply & Forecast
  - 1.2.1 World Die Attach Carrier Substrate Production Value (2018 & 2022 & 2029)
  - 1.2.2 World Die Attach Carrier Substrate Production (2018-2029)
  - 1.2.3 World Die Attach Carrier Substrate Pricing Trends (2018-2029)
- 1.3 World Die Attach Carrier Substrate Production by Region (Based on Production Site)
  - 1.3.1 World Die Attach Carrier Substrate Production Value by Region (2018-2029)
  - 1.3.2 World Die Attach Carrier Substrate Production by Region (2018-2029)
  - 1.3.3 World Die Attach Carrier Substrate Average Price by Region (2018-2029)
  - 1.3.4 North America Die Attach Carrier Substrate Production (2018-2029)
  - 1.3.5 Europe Die Attach Carrier Substrate Production (2018-2029)
  - 1.3.6 China Die Attach Carrier Substrate Production (2018-2029)
  - 1.3.7 Japan Die Attach Carrier Substrate Production (2018-2029)
  - 1.3.8 South Korea Die Attach Carrier Substrate Production (2018-2029)
- 1.4 Market Drivers, Restraints and Trends
  - 1.4.1 Die Attach Carrier Substrate Market Drivers
  - 1.4.2 Factors Affecting Demand
  - 1.4.3 Die Attach Carrier Substrate Major Market Trends

### 2 DEMAND SUMMARY

- 2.1 World Die Attach Carrier Substrate Demand (2018-2029)
- 2.2 World Die Attach Carrier Substrate Consumption by Region
  - 2.2.1 World Die Attach Carrier Substrate Consumption by Region (2018-2023)
  - 2.2.2 World Die Attach Carrier Substrate Consumption Forecast by Region (2024-2029)
- 2.3 United States Die Attach Carrier Substrate Consumption (2018-2029)
- 2.4 China Die Attach Carrier Substrate Consumption (2018-2029)
- 2.5 Europe Die Attach Carrier Substrate Consumption (2018-2029)
- 2.6 Japan Die Attach Carrier Substrate Consumption (2018-2029)
- 2.7 South Korea Die Attach Carrier Substrate Consumption (2018-2029)
- 2.8 ASEAN Die Attach Carrier Substrate Consumption (2018-2029)
- 2.9 India Die Attach Carrier Substrate Consumption (2018-2029)

### **3 WORLD DIE ATTACH CARRIER SUBSTRATE MANUFACTURERS COMPETITIVE ANALYSIS**

- 3.1 World Die Attach Carrier Substrate Production Value by Manufacturer (2018-2023)
- 3.2 World Die Attach Carrier Substrate Production by Manufacturer (2018-2023)
- 3.3 World Die Attach Carrier Substrate Average Price by Manufacturer (2018-2023)
- 3.4 Die Attach Carrier Substrate Company Evaluation Quadrant
- 3.5 Industry Rank and Concentration Rate (CR)
  - 3.5.1 Global Die Attach Carrier Substrate Industry Rank of Major Manufacturers
  - 3.5.2 Global Concentration Ratios (CR4) for Die Attach Carrier Substrate in 2022
  - 3.5.3 Global Concentration Ratios (CR8) for Die Attach Carrier Substrate in 2022
- 3.6 Die Attach Carrier Substrate Market: Overall Company Footprint Analysis
  - 3.6.1 Die Attach Carrier Substrate Market: Region Footprint
  - 3.6.2 Die Attach Carrier Substrate Market: Company Product Type Footprint
  - 3.6.3 Die Attach Carrier Substrate Market: Company Product Application Footprint
- 3.7 Competitive Environment
  - 3.7.1 Historical Structure of the Industry
  - 3.7.2 Barriers of Market Entry
  - 3.7.3 Factors of Competition
- 3.8 New Entrant and Capacity Expansion Plans
- 3.9 Mergers, Acquisition, Agreements, and Collaborations

### **4 UNITED STATES VS CHINA VS REST OF THE WORLD**

- 4.1 United States VS China: Die Attach Carrier Substrate Production Value Comparison
  - 4.1.1 United States VS China: Die Attach Carrier Substrate Production Value Comparison (2018 & 2022 & 2029)
  - 4.1.2 United States VS China: Die Attach Carrier Substrate Production Value Market Share Comparison (2018 & 2022 & 2029)
- 4.2 United States VS China: Die Attach Carrier Substrate Production Comparison
  - 4.2.1 United States VS China: Die Attach Carrier Substrate Production Comparison (2018 & 2022 & 2029)
  - 4.2.2 United States VS China: Die Attach Carrier Substrate Production Market Share Comparison (2018 & 2022 & 2029)
- 4.3 United States VS China: Die Attach Carrier Substrate Consumption Comparison
  - 4.3.1 United States VS China: Die Attach Carrier Substrate Consumption Comparison (2018 & 2022 & 2029)
  - 4.3.2 United States VS China: Die Attach Carrier Substrate Consumption Market Share Comparison (2018 & 2022 & 2029)

#### 4.4 United States Based Die Attach Carrier Substrate Manufacturers and Market Share, 2018-2023

4.4.1 United States Based Die Attach Carrier Substrate Manufacturers, Headquarters and Production Site (States, Country)

4.4.2 United States Based Manufacturers Die Attach Carrier Substrate Production Value (2018-2023)

4.4.3 United States Based Manufacturers Die Attach Carrier Substrate Production (2018-2023)

#### 4.5 China Based Die Attach Carrier Substrate Manufacturers and Market Share

4.5.1 China Based Die Attach Carrier Substrate Manufacturers, Headquarters and Production Site (Province, Country)

4.5.2 China Based Manufacturers Die Attach Carrier Substrate Production Value (2018-2023)

4.5.3 China Based Manufacturers Die Attach Carrier Substrate Production (2018-2023)

#### 4.6 Rest of World Based Die Attach Carrier Substrate Manufacturers and Market Share, 2018-2023

4.6.1 Rest of World Based Die Attach Carrier Substrate Manufacturers, Headquarters and Production Site (State, Country)

4.6.2 Rest of World Based Manufacturers Die Attach Carrier Substrate Production Value (2018-2023)

4.6.3 Rest of World Based Manufacturers Die Attach Carrier Substrate Production (2018-2023)

### **5 MARKET ANALYSIS BY TYPE**

#### 5.1 World Die Attach Carrier Substrate Market Size Overview by Type: 2018 VS 2022 VS 2029

#### 5.2 Segment Introduction by Type

5.2.1 PCB Substrate

5.2.2 Si Substrate

5.2.3 GaAs Substrate

5.2.4 SiC Substrate

#### 5.3 Market Segment by Type

5.3.1 World Die Attach Carrier Substrate Production by Type (2018-2029)

5.3.2 World Die Attach Carrier Substrate Production Value by Type (2018-2029)

5.3.3 World Die Attach Carrier Substrate Average Price by Type (2018-2029)

### **6 MARKET ANALYSIS BY APPLICATION**



6.1 World Die Attach Carrier Substrate Market Size Overview by Application: 2018 VS 2022 VS 2029

6.2 Segment Introduction by Application

6.2.1 Automobile Industry

6.2.2 Medical Industry

6.2.3 Aerospace Industry

6.2.4 Others

6.3 Market Segment by Application

6.3.1 World Die Attach Carrier Substrate Production by Application (2018-2029)

6.3.2 World Die Attach Carrier Substrate Production Value by Application (2018-2029)

6.3.3 World Die Attach Carrier Substrate Average Price by Application (2018-2029)

## **7 COMPANY PROFILES**

7.1 Kyocera

7.1.1 Kyocera Details

7.1.2 Kyocera Major Business

7.1.3 Kyocera Die Attach Carrier Substrate Product and Services

7.1.4 Kyocera Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.1.5 Kyocera Recent Developments/Updates

7.1.6 Kyocera Competitive Strengths & Weaknesses

7.2 Shinko Electric Industries

7.2.1 Shinko Electric Industries Details

7.2.2 Shinko Electric Industries Major Business

7.2.3 Shinko Electric Industries Die Attach Carrier Substrate Product and Services

7.2.4 Shinko Electric Industries Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.2.5 Shinko Electric Industries Recent Developments/Updates

7.2.6 Shinko Electric Industries Competitive Strengths & Weaknesses

7.3 Hitachi Chemical

7.3.1 Hitachi Chemical Details

7.3.2 Hitachi Chemical Major Business

7.3.3 Hitachi Chemical Die Attach Carrier Substrate Product and Services

7.3.4 Hitachi Chemical Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.3.5 Hitachi Chemical Recent Developments/Updates

7.3.6 Hitachi Chemical Competitive Strengths & Weaknesses

## 7.4 Sumitomo Bakelite

### 7.4.1 Sumitomo Bakelite Details

### 7.4.2 Sumitomo Bakelite Major Business

### 7.4.3 Sumitomo Bakelite Die Attach Carrier Substrate Product and Services

### 7.4.4 Sumitomo Bakelite Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.4.5 Sumitomo Bakelite Recent Developments/Updates

### 7.4.6 Sumitomo Bakelite Competitive Strengths & Weaknesses

## 7.5 Mitsui High-tec

### 7.5.1 Mitsui High-tec Details

### 7.5.2 Mitsui High-tec Major Business

### 7.5.3 Mitsui High-tec Die Attach Carrier Substrate Product and Services

### 7.5.4 Mitsui High-tec Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.5.5 Mitsui High-tec Recent Developments/Updates

### 7.5.6 Mitsui High-tec Competitive Strengths & Weaknesses

## 7.6 Nippon Electric Glass

### 7.6.1 Nippon Electric Glass Details

### 7.6.2 Nippon Electric Glass Major Business

### 7.6.3 Nippon Electric Glass Die Attach Carrier Substrate Product and Services

### 7.6.4 Nippon Electric Glass Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.6.5 Nippon Electric Glass Recent Developments/Updates

### 7.6.6 Nippon Electric Glass Competitive Strengths & Weaknesses

## 7.7 Toray Industries

### 7.7.1 Toray Industries Details

### 7.7.2 Toray Industries Major Business

### 7.7.3 Toray Industries Die Attach Carrier Substrate Product and Services

### 7.7.4 Toray Industries Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.7.5 Toray Industries Recent Developments/Updates

### 7.7.6 Toray Industries Competitive Strengths & Weaknesses

## 7.8 Panasonic

### 7.8.1 Panasonic Details

### 7.8.2 Panasonic Major Business

### 7.8.3 Panasonic Die Attach Carrier Substrate Product and Services

### 7.8.4 Panasonic Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.8.5 Panasonic Recent Developments/Updates

- 7.8.6 Panasonic Competitive Strengths & Weaknesses
- 7.9 LG Innotek
  - 7.9.1 LG Innotek Details
  - 7.9.2 LG Innotek Major Business
  - 7.9.3 LG Innotek Die Attach Carrier Substrate Product and Services
  - 7.9.4 LG Innotek Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.9.5 LG Innotek Recent Developments/Updates
  - 7.9.6 LG Innotek Competitive Strengths & Weaknesses
- 7.10 Samsung Electro-Mechanics
  - 7.10.1 Samsung Electro-Mechanics Details
  - 7.10.2 Samsung Electro-Mechanics Major Business
  - 7.10.3 Samsung Electro-Mechanics Die Attach Carrier Substrate Product and Services
  - 7.10.4 Samsung Electro-Mechanics Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.10.5 Samsung Electro-Mechanics Recent Developments/Updates
  - 7.10.6 Samsung Electro-Mechanics Competitive Strengths & Weaknesses
- 7.11 Murata Manufacturing
  - 7.11.1 Murata Manufacturing Details
  - 7.11.2 Murata Manufacturing Major Business
  - 7.11.3 Murata Manufacturing Die Attach Carrier Substrate Product and Services
  - 7.11.4 Murata Manufacturing Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.11.5 Murata Manufacturing Recent Developments/Updates
  - 7.11.6 Murata Manufacturing Competitive Strengths & Weaknesses
- 7.12 Taiyo Yuden
  - 7.12.1 Taiyo Yuden Details
  - 7.12.2 Taiyo Yuden Major Business
  - 7.12.3 Taiyo Yuden Die Attach Carrier Substrate Product and Services
  - 7.12.4 Taiyo Yuden Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.12.5 Taiyo Yuden Recent Developments/Updates
  - 7.12.6 Taiyo Yuden Competitive Strengths & Weaknesses
- 7.13 TDK Corporation
  - 7.13.1 TDK Corporation Details
  - 7.13.2 TDK Corporation Major Business
  - 7.13.3 TDK Corporation Die Attach Carrier Substrate Product and Services
  - 7.13.4 TDK Corporation Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)

- 7.13.5 TDK Corporation Recent Developments/Updates
- 7.13.6 TDK Corporation Competitive Strengths & Weaknesses
- 7.14 KEMET Corporation
  - 7.14.1 KEMET Corporation Details
  - 7.14.2 KEMET Corporation Major Business
  - 7.14.3 KEMET Corporation Die Attach Carrier Substrate Product and Services
  - 7.14.4 KEMET Corporation Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.14.5 KEMET Corporation Recent Developments/Updates
  - 7.14.6 KEMET Corporation Competitive Strengths & Weaknesses
- 7.15 Vishay Intertechnology
  - 7.15.1 Vishay Intertechnology Details
  - 7.15.2 Vishay Intertechnology Major Business
  - 7.15.3 Vishay Intertechnology Die Attach Carrier Substrate Product and Services
  - 7.15.4 Vishay Intertechnology Die Attach Carrier Substrate Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.15.5 Vishay Intertechnology Recent Developments/Updates
  - 7.15.6 Vishay Intertechnology Competitive Strengths & Weaknesses

## **8 INDUSTRY CHAIN ANALYSIS**

- 8.1 Die Attach Carrier Substrate Industry Chain
- 8.2 Die Attach Carrier Substrate Upstream Analysis
  - 8.2.1 Die Attach Carrier Substrate Core Raw Materials
  - 8.2.2 Main Manufacturers of Die Attach Carrier Substrate Core Raw Materials
- 8.3 Midstream Analysis
- 8.4 Downstream Analysis
- 8.5 Die Attach Carrier Substrate Production Mode
- 8.6 Die Attach Carrier Substrate Procurement Model
- 8.7 Die Attach Carrier Substrate Industry Sales Model and Sales Channels
  - 8.7.1 Die Attach Carrier Substrate Sales Model
  - 8.7.2 Die Attach Carrier Substrate Typical Customers

## **9 RESEARCH FINDINGS AND CONCLUSION**

## **10 APPENDIX**

- 10.1 Methodology

10.2 Research Process and Data Source

10.3 Disclaimer

## List Of Tables

### LIST OF TABLES

Table 1. World Die Attach Carrier Substrate Production Value by Region (2018, 2022 and 2029) & (USD Million)

Table 2. World Die Attach Carrier Substrate Production Value by Region (2018-2023) & (USD Million)

Table 3. World Die Attach Carrier Substrate Production Value by Region (2024-2029) & (USD Million)

Table 4. World Die Attach Carrier Substrate Production Value Market Share by Region (2018-2023)

Table 5. World Die Attach Carrier Substrate Production Value Market Share by Region (2024-2029)

Table 6. World Die Attach Carrier Substrate Production by Region (2018-2023) & (K Units)

Table 7. World Die Attach Carrier Substrate Production by Region (2024-2029) & (K Units)

Table 8. World Die Attach Carrier Substrate Production Market Share by Region (2018-2023)

Table 9. World Die Attach Carrier Substrate Production Market Share by Region (2024-2029)

Table 10. World Die Attach Carrier Substrate Average Price by Region (2018-2023) & (US\$/Unit)

Table 11. World Die Attach Carrier Substrate Average Price by Region (2024-2029) & (US\$/Unit)

Table 12. Die Attach Carrier Substrate Major Market Trends

Table 13. World Die Attach Carrier Substrate Consumption Growth Rate Forecast by Region (2018 & 2022 & 2029) & (K Units)

Table 14. World Die Attach Carrier Substrate Consumption by Region (2018-2023) & (K Units)

Table 15. World Die Attach Carrier Substrate Consumption Forecast by Region (2024-2029) & (K Units)

Table 16. World Die Attach Carrier Substrate Production Value by Manufacturer (2018-2023) & (USD Million)

Table 17. Production Value Market Share of Key Die Attach Carrier Substrate Producers in 2022

Table 18. World Die Attach Carrier Substrate Production by Manufacturer (2018-2023) & (K Units)

Table 19. Production Market Share of Key Die Attach Carrier Substrate Producers in 2022

Table 20. World Die Attach Carrier Substrate Average Price by Manufacturer (2018-2023) & (US\$/Unit)

Table 21. Global Die Attach Carrier Substrate Company Evaluation Quadrant

Table 22. World Die Attach Carrier Substrate Industry Rank of Major Manufacturers, Based on Production Value in 2022

Table 23. Head Office and Die Attach Carrier Substrate Production Site of Key Manufacturer

Table 24. Die Attach Carrier Substrate Market: Company Product Type Footprint

Table 25. Die Attach Carrier Substrate Market: Company Product Application Footprint

Table 26. Die Attach Carrier Substrate Competitive Factors

Table 27. Die Attach Carrier Substrate New Entrant and Capacity Expansion Plans

Table 28. Die Attach Carrier Substrate Mergers & Acquisitions Activity

Table 29. United States VS China Die Attach Carrier Substrate Production Value Comparison, (2018 & 2022 & 2029) & (USD Million)

Table 30. United States VS China Die Attach Carrier Substrate Production Comparison, (2018 & 2022 & 2029) & (K Units)

Table 31. United States VS China Die Attach Carrier Substrate Consumption Comparison, (2018 & 2022 & 2029) & (K Units)

Table 32. United States Based Die Attach Carrier Substrate Manufacturers, Headquarters and Production Site (States, Country)

Table 33. United States Based Manufacturers Die Attach Carrier Substrate Production Value, (2018-2023) & (USD Million)

Table 34. United States Based Manufacturers Die Attach Carrier Substrate Production Value Market Share (2018-2023)

Table 35. United States Based Manufacturers Die Attach Carrier Substrate Production (2018-2023) & (K Units)

Table 36. United States Based Manufacturers Die Attach Carrier Substrate Production Market Share (2018-2023)

Table 37. China Based Die Attach Carrier Substrate Manufacturers, Headquarters and Production Site (Province, Country)

Table 38. China Based Manufacturers Die Attach Carrier Substrate Production Value, (2018-2023) & (USD Million)

Table 39. China Based Manufacturers Die Attach Carrier Substrate Production Value Market Share (2018-2023)

Table 40. China Based Manufacturers Die Attach Carrier Substrate Production (2018-2023) & (K Units)

Table 41. China Based Manufacturers Die Attach Carrier Substrate Production Market



Share (2018-2023)

Table 42. Rest of World Based Die Attach Carrier Substrate Manufacturers, Headquarters and Production Site (States, Country)

Table 43. Rest of World Based Manufacturers Die Attach Carrier Substrate Production Value, (2018-2023) & (USD Million)

Table 44. Rest of World Based Manufacturers Die Attach Carrier Substrate Production Value Market Share (2018-2023)

Table 45. Rest of World Based Manufacturers Die Attach Carrier Substrate Production (2018-2023) & (K Units)

Table 46. Rest of World Based Manufacturers Die Attach Carrier Substrate Production Market Share (2018-2023)

Table 47. World Die Attach Carrier Substrate Production Value by Type, (USD Million), 2018 & 2022 & 2029

Table 48. World Die Attach Carrier Substrate Production by Type (2018-2023) & (K Units)

Table 49. World Die Attach Carrier Substrate Production by Type (2024-2029) & (K Units)

Table 50. World Die Attach Carrier Substrate Production Value by Type (2018-2023) & (USD Million)

Table 51. World Die Attach Carrier Substrate Production Value by Type (2024-2029) & (USD Million)

Table 52. World Die Attach Carrier Substrate Average Price by Type (2018-2023) & (US\$/Unit)

Table 53. World Die Attach Carrier Substrate Average Price by Type (2024-2029) & (US\$/Unit)

Table 54. World Die Attach Carrier Substrate Production Value by Application, (USD Million), 2018 & 2022 & 2029

Table 55. World Die Attach Carrier Substrate Production by Application (2018-2023) & (K Units)

Table 56. World Die Attach Carrier Substrate Production by Application (2024-2029) & (K Units)

Table 57. World Die Attach Carrier Substrate Production Value by Application (2018-2023) & (USD Million)

Table 58. World Die Attach Carrier Substrate Production Value by Application (2024-2029) & (USD Million)

Table 59. World Die Attach Carrier Substrate Average Price by Application (2018-2023) & (US\$/Unit)

Table 60. World Die Attach Carrier Substrate Average Price by Application (2024-2029) & (US\$/Unit)



- Table 61. Kyocera Basic Information, Manufacturing Base and Competitors
- Table 62. Kyocera Major Business
- Table 63. Kyocera Die Attach Carrier Substrate Product and Services
- Table 64. Kyocera Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 65. Kyocera Recent Developments/Updates
- Table 66. Kyocera Competitive Strengths & Weaknesses
- Table 67. Shinko Electric Industries Basic Information, Manufacturing Base and Competitors
- Table 68. Shinko Electric Industries Major Business
- Table 69. Shinko Electric Industries Die Attach Carrier Substrate Product and Services
- Table 70. Shinko Electric Industries Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 71. Shinko Electric Industries Recent Developments/Updates
- Table 72. Shinko Electric Industries Competitive Strengths & Weaknesses
- Table 73. Hitachi Chemical Basic Information, Manufacturing Base and Competitors
- Table 74. Hitachi Chemical Major Business
- Table 75. Hitachi Chemical Die Attach Carrier Substrate Product and Services
- Table 76. Hitachi Chemical Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 77. Hitachi Chemical Recent Developments/Updates
- Table 78. Hitachi Chemical Competitive Strengths & Weaknesses
- Table 79. Sumitomo Bakelite Basic Information, Manufacturing Base and Competitors
- Table 80. Sumitomo Bakelite Major Business
- Table 81. Sumitomo Bakelite Die Attach Carrier Substrate Product and Services
- Table 82. Sumitomo Bakelite Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 83. Sumitomo Bakelite Recent Developments/Updates
- Table 84. Sumitomo Bakelite Competitive Strengths & Weaknesses
- Table 85. Mitsui High-tec Basic Information, Manufacturing Base and Competitors
- Table 86. Mitsui High-tec Major Business
- Table 87. Mitsui High-tec Die Attach Carrier Substrate Product and Services
- Table 88. Mitsui High-tec Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 89. Mitsui High-tec Recent Developments/Updates

- Table 90. Mitsui High-tec Competitive Strengths & Weaknesses
- Table 91. Nippon Electric Glass Basic Information, Manufacturing Base and Competitors
- Table 92. Nippon Electric Glass Major Business
- Table 93. Nippon Electric Glass Die Attach Carrier Substrate Product and Services
- Table 94. Nippon Electric Glass Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 95. Nippon Electric Glass Recent Developments/Updates
- Table 96. Nippon Electric Glass Competitive Strengths & Weaknesses
- Table 97. Toray Industries Basic Information, Manufacturing Base and Competitors
- Table 98. Toray Industries Major Business
- Table 99. Toray Industries Die Attach Carrier Substrate Product and Services
- Table 100. Toray Industries Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 101. Toray Industries Recent Developments/Updates
- Table 102. Toray Industries Competitive Strengths & Weaknesses
- Table 103. Panasonic Basic Information, Manufacturing Base and Competitors
- Table 104. Panasonic Major Business
- Table 105. Panasonic Die Attach Carrier Substrate Product and Services
- Table 106. Panasonic Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 107. Panasonic Recent Developments/Updates
- Table 108. Panasonic Competitive Strengths & Weaknesses
- Table 109. LG Innotek Basic Information, Manufacturing Base and Competitors
- Table 110. LG Innotek Major Business
- Table 111. LG Innotek Die Attach Carrier Substrate Product and Services
- Table 112. LG Innotek Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 113. LG Innotek Recent Developments/Updates
- Table 114. LG Innotek Competitive Strengths & Weaknesses
- Table 115. Samsung Electro-Mechanics Basic Information, Manufacturing Base and Competitors
- Table 116. Samsung Electro-Mechanics Major Business
- Table 117. Samsung Electro-Mechanics Die Attach Carrier Substrate Product and Services

Table 118. Samsung Electro-Mechanics Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 119. Samsung Electro-Mechanics Recent Developments/Updates

Table 120. Samsung Electro-Mechanics Competitive Strengths & Weaknesses

Table 121. Murata Manufacturing Basic Information, Manufacturing Base and Competitors

Table 122. Murata Manufacturing Major Business

Table 123. Murata Manufacturing Die Attach Carrier Substrate Product and Services

Table 124. Murata Manufacturing Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 125. Murata Manufacturing Recent Developments/Updates

Table 126. Murata Manufacturing Competitive Strengths & Weaknesses

Table 127. Taiyo Yuden Basic Information, Manufacturing Base and Competitors

Table 128. Taiyo Yuden Major Business

Table 129. Taiyo Yuden Die Attach Carrier Substrate Product and Services

Table 130. Taiyo Yuden Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 131. Taiyo Yuden Recent Developments/Updates

Table 132. Taiyo Yuden Competitive Strengths & Weaknesses

Table 133. TDK Corporation Basic Information, Manufacturing Base and Competitors

Table 134. TDK Corporation Major Business

Table 135. TDK Corporation Die Attach Carrier Substrate Product and Services

Table 136. TDK Corporation Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 137. TDK Corporation Recent Developments/Updates

Table 138. TDK Corporation Competitive Strengths & Weaknesses

Table 139. KEMET Corporation Basic Information, Manufacturing Base and Competitors

Table 140. KEMET Corporation Major Business

Table 141. KEMET Corporation Die Attach Carrier Substrate Product and Services

Table 142. KEMET Corporation Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 143. KEMET Corporation Recent Developments/Updates

Table 144. Vishay Intertechnology Basic Information, Manufacturing Base and

## Competitors

Table 145. Vishay Intertechnology Major Business

Table 146. Vishay Intertechnology Die Attach Carrier Substrate Product and Services

Table 147. Vishay Intertechnology Die Attach Carrier Substrate Production (K Units), Price (US\$/Unit), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 148. Global Key Players of Die Attach Carrier Substrate Upstream (Raw Materials)

Table 149. Die Attach Carrier Substrate Typical Customers

Table 150. Die Attach Carrier Substrate Typical Distributors

## List of Figure

Figure 1. Die Attach Carrier Substrate Picture

Figure 2. World Die Attach Carrier Substrate Production Value: 2018 & 2022 & 2029, (USD Million)

Figure 3. World Die Attach Carrier Substrate Production Value and Forecast (2018-2029) & (USD Million)

Figure 4. World Die Attach Carrier Substrate Production (2018-2029) & (K Units)

Figure 5. World Die Attach Carrier Substrate Average Price (2018-2029) & (US\$/Unit)

Figure 6. World Die Attach Carrier Substrate Production Value Market Share by Region (2018-2029)

Figure 7. World Die Attach Carrier Substrate Production Market Share by Region (2018-2029)

Figure 8. North America Die Attach Carrier Substrate Production (2018-2029) & (K Units)

Figure 9. Europe Die Attach Carrier Substrate Production (2018-2029) & (K Units)

Figure 10. China Die Attach Carrier Substrate Production (2018-2029) & (K Units)

Figure 11. Japan Die Attach Carrier Substrate Production (2018-2029) & (K Units)

Figure 12. South Korea Die Attach Carrier Substrate Production (2018-2029) & (K Units)

Figure 13. Die Attach Carrier Substrate Market Drivers

Figure 14. Factors Affecting Demand

Figure 15. World Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 16. World Die Attach Carrier Substrate Consumption Market Share by Region (2018-2029)

Figure 17. United States Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 18. China Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 19. Europe Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 20. Japan Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 21. South Korea Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 22. ASEAN Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 23. India Die Attach Carrier Substrate Consumption (2018-2029) & (K Units)

Figure 24. Producer Shipments of Die Attach Carrier Substrate by Manufacturer Revenue (\$MM) and Market Share (%): 2022

Figure 25. Global Four-firm Concentration Ratios (CR4) for Die Attach Carrier Substrate Markets in 2022

Figure 26. Global Four-firm Concentration Ratios (CR8) for Die Attach Carrier Substrate Markets in 2022

Figure 27. United States VS China: Die Attach Carrier Substrate Production Value Market Share Comparison (2018 & 2022 & 2029)

Figure 28. United States VS China: Die Attach Carrier Substrate Production Market Share Comparison (2018 & 2022 & 2029)

Figure 29. United States VS China: Die Attach Carrier Substrate Consumption Market Share Comparison (2018 & 2022 & 2029)

Figure 30. United States Based Manufacturers Die Attach Carrier Substrate Production Market Share 2022

Figure 31. China Based Manufacturers Die Attach Carrier Substrate Production Market Share 2022

Figure 32. Rest of World Based Manufacturers Die Attach Carrier Substrate Production Market Share 2022

Figure 33. World Die Attach Carrier Substrate Production Value by Type, (USD Million), 2018 & 2022 & 2029

Figure 34. World Die Attach Carrier Substrate Production Value Market Share by Type in 2022

Figure 35. PCB Substrate

Figure 36. Si Substrate

Figure 37. GaAs Substrate

Figure 38. SiC Substrate

Figure 39. World Die Attach Carrier Substrate Production Market Share by Type (2018-2029)

Figure 40. World Die Attach Carrier Substrate Production Value Market Share by Type (2018-2029)

Figure 41. World Die Attach Carrier Substrate Average Price by Type (2018-2029) & (US\$/Unit)

Figure 42. World Die Attach Carrier Substrate Production Value by Application, (USD Million), 2018 & 2022 & 2029

Figure 43. World Die Attach Carrier Substrate Production Value Market Share by

Application in 2022

Figure 44. Automobile Industry

Figure 45. Medical Industry

Figure 46. Aerospace Industry

Figure 47. Others

Figure 48. World Die Attach Carrier Substrate Production Market Share by Application (2018-2029)

Figure 49. World Die Attach Carrier Substrate Production Value Market Share by Application (2018-2029)

Figure 50. World Die Attach Carrier Substrate Average Price by Application (2018-2029) & (US\$/Unit)

Figure 51. Die Attach Carrier Substrate Industry Chain

Figure 52. Die Attach Carrier Substrate Procurement Model

Figure 53. Die Attach Carrier Substrate Sales Model

Figure 54. Die Attach Carrier Substrate Sales Channels, Direct Sales, and Distribution

Figure 55. Methodology

Figure 56. Research Process and Data Source



## I would like to order

Product name: Global Die Attach Carrier Substrate Supply, Demand and Key Producers, 2023-2029

Product link: <https://marketpublishers.com/r/G2A8810B7AC5EN.html>

Price: US\$ 4,480.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

[info@marketpublishers.com](mailto:info@marketpublishers.com)

## Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/G2A8810B7AC5EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:  
Last name:  
Email:  
Company:  
Address:  
City:  
Zip code:  
Country:  
Tel:  
Fax:  
Your message:

**\*\*All fields are required**

Customer signature \_\_\_\_\_

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970